

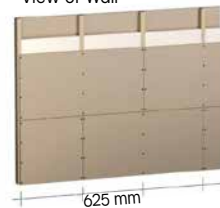
# ClayTec clay building board D22 solar

**Art. 09.100**

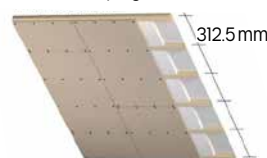
- **Dimensionally stable**
- **Form-stable**
- **Easy to handle**
- **Solar dried**
- **100% CO<sub>2</sub>-neutral production**



View of Wall



View of Sloping Roof



ClayTec D22 solar clay building boards are manufactured using a 100 percent CO<sub>2</sub>-neutral process. Drying is carried out exclusively with solar energy, with the solar heat fed directly into the drying process. As a result, production follows the rhythm of the seasons.

The drywall panel, made of clay and miscanthus fibers, is highly dimensionally stable, sturdy, and easy to handle. It is used for cladding wooden and metal stud constructions in interior walls, facing shells, ceilings, and roof surfaces.

The ClayTec D22 solar clay building board combines drywall panel and clay plaster in one. It provides heat protection in summer and helps balance the indoor climate. It serves as the basis for many ClayTec clay surface coatings, offering solutions for every customer requirement.

The pilot project for developing the first purely solar-powered drying process for producing clay building boards was funded by the German Federal Environmental Foundation under project number Az 35520/01.

**ClayTec**<sup>®</sup>

**GERMANY**

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Nettetal Straße 113-117

D-41751 Viersen-Boisheim

+49 (0)2153 918-0

service@claytec.com

claytec.com

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Changes and errors excepted.

Current version available at

**claytec.com**

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## Art. 09.100

**Area of application** Clay building board for cladding wooden and metal post constructions indoors. For interior walls and facing shells. On surfaces of water impact class W0-I according to DIN 18534-1, e.g. B. in bathrooms (except shower areas) and domestic kitchens.

**Composition** Building clay, miscanthus fibers, starch (approx. 0.2 %), paper backing, jute fabric insert close to the surface, top layer with fine straw fibers.

**Manufacturing** Processing and shaping process with green electricity, drying exclusively by solar power.

**Material Properties** Bulk density: approx. 1000 kg/m<sup>3</sup>, Thermal conductivity: 0.30 W/m·K, Water vapor diffusion resistance factor ( $\mu$ ): 18, Thermal storage capacity: Specific heat capacity ( $C_p$ ): 1.1 kJ/kg·K, Areal heat capacity (D22): 21.8 kJ/m<sup>2</sup>·K

**Mass and weight** D=approx. 22 mm, L = 1,250 mm, W = 625 mm. Area per panel approx. 0.78 m<sup>2</sup>. Mass approx. 17.5 kg/panel = approx. 19.8 kg/m<sup>2</sup>

**Delivery form** Sealed on pallets of 50 pieces each

**Storage** Lying on pallets in the warehouse, dry. Storage is possible indefinitely. Protect from moisture during transport and storage on the construction site. For larger quantities, we recommend the ClayTec transport aid 182/400. Lying on the construction site and stored flat on dry pallets or pieces of wood.

**Humidity** Moisture stress from wet installed plasters and screeds is not permitted. In general, the relative humidity during storage and after installation must not exceed 70 %.

**Material requirements** Approx. 1.28 panels/m<sup>2</sup>. When determining the material requirements, a reserve of approx. 10 % for waste etc. must be taken into account.

**Substructure** Wooden stand: Solid wood (softwood) according to DIN EN 14081-1 or glued laminated timber (BSH) according to DIN EN 14080. Strength class at least C24 according to DIN EN 338. Sorting class S10 according to DIN 4074. Moisture content max. 18 %. Metal stand: Sheet steel profiles according to DIN 18182-1 / DIN EN 14195.

Grid walls: Distance between axes 625 mm (= 1,250 mm/2).

Grid ceilings and sloping roofs: Distance between axis dimensions max. 312.5 mm (= 1,250 mm/4).

The wall-encircling UK links are backed with ClayTec drywall tape and fastened according to the rules of technology. When it comes to the stud structure, it must be taken into account that the panels are attached at an angle of 90° to the substructure. If, in exceptional cases, they are laid parallel to the substructure, the distance between the substructure may not exceed 312.5 mm (= 625 mm/2). We strongly advise against direct attachment to load-bearing components (e.g. rafters, ceiling beams).

**Processing** The panels are cut with a jigsaw or a hand-held circular saw. The FESTOOL diamond cutting system is particularly suitable DSC-AG 125 Plus-FS, see also clip on [claytec.link/Lehmtrockenbau](https://claytec.link/Lehmtrockenbau)

The clay side of the board should be plastered, not the paper side. The lowest row of panels is installed with some distance ("air") from the floor. The panels are fitted onto the substructure as seamlessly as possible.

**Screws:** Fastening to wood with ClayTec clay building board screws 5 x 50 mm or FN drywall screws with coarse thread. On metal C profile with FN drywall screws with fine double thread, on UA profile with TB drywall screw and countersunk washer. Screw spacing  $\leq$  200 mm, i.e. 4 fastening points are required per plate/substructure intersection (wall 16, ceiling 20 screws/plate). Countersink the screws slightly (flush with the plate).

**Staples:** Fastening to wood with 45 mm staples, e.g., Haubold item no. 574941 KG 745 Cnk resin-coated, 12  $\mu$ m (ETA approved). Maximum staple spacing:  $\leq$  80 mm. Staples must be driven flush with the board surface—not countersunk.

Cross joints and the continuation of wall opening boundaries through horizontal or vertical joints are not permitted. The assembly is carried out with joints offset by a stand center distance. Make connections to other components such as solid walls and ceilings with joints.

**Further treatment** For joint and coating work, the room temperature must not fall below +10°C. Basically, the moisture entry through the plaster must be kept as low as possible. The panel joint around the wall is filled with ClayTec clay joint filler. Carefully dust the panels before applying the mortar.

Gaps  $\geq$  1 mm wide to the full cross-sectional depth with clay adhesive and reinforcing mortar. Close screw or staple holes and any imperfections. Even out any significant differences in thickness at the joints. If necessary, lightly moisten (spray mist) and allow to dry between steps.

**Thin layer coating:** Close screw holes and surface defects beforehand. After drying, apply a 3 mm thick coat of ClayTec clay adhesive and reinforcing mortar or clay finishing plaster, close screw recesses and missing areas, allow to dry. It can also be sprayed on with a plastering machine; rest periods are not necessary for this application. While still wet, embed ClayTec Glass Mesh 112 across the entire surface.

Alternatively, execute the reinforcement layer ready for paint application (fresh-on-fresh coating, approx. 1 mm). Once dry, the surface may also be finished with ClayTec clay topcoat fine 06 or clay filling and smoothing putty (Q3). Finish with ClayTec clay paint (ready to use) or the ClayFix clay coating system.

**Wall surface heating:** Close gaps  $\geq$  1 mm wide as before. Pre-spray up to max. 8 mm with clay base plaster, straw, clay plaster mineral or SanReMo. After drying, fill up to the top of the wall heating pipe. Drying of the entire concealed plaster with heating support. For more information, see the ClayTec clay plaster worksheet.

**Notice** The proof and declaration according to DIN 18948 "Clay panels – requirements, testing and labeling" will be available shortly.

**Claims for compensation that do not result from factory mixing errors are excluded.**

Subject to change and errors excepted. As of 2025/9.